# PNZ300 (PN300), PNZ300F (PN300F)

# Silicon planar type

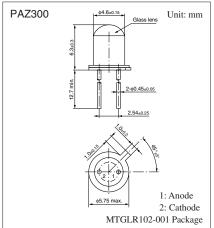
### For optical control systems

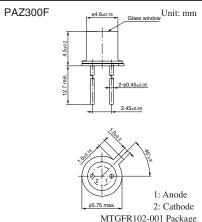
#### ■ Features

- Fast response which is well suited to high speed modulated light
- Wide spectral sensitivity
- · Low dark current and low noise
- Good photo current linearity and wide dynamic sensitivity
- Narrow directivity (PNZ300)
- Wide derectivity (PNZ300F)

## ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit
Reverse voltage	V <sub>R</sub>	50	V
Power dissipation	$P_{\mathrm{D}}$	100	mW
Operating ambient temperature	Topr	-25 to +85	°C
Storage temperature	T <sub>stg</sub>	-30 to +100	°C





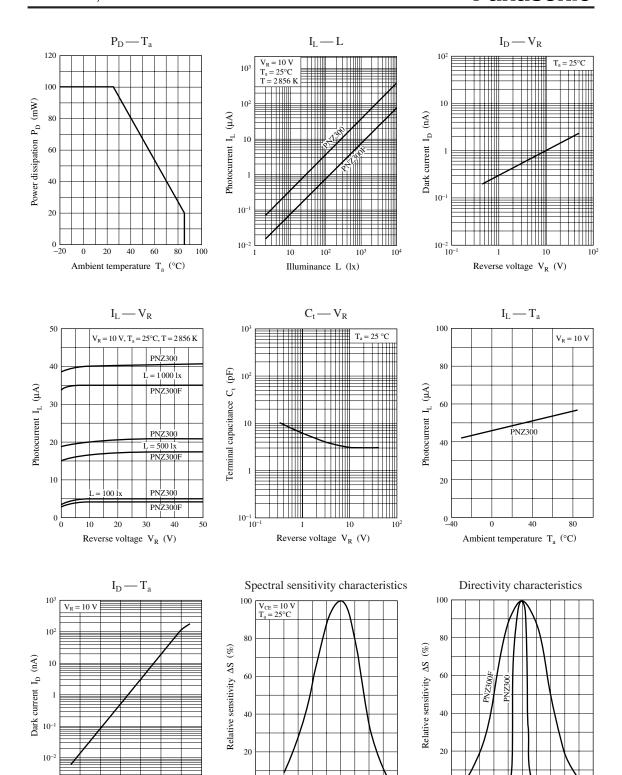
### ■ Electrical-Optical Characteristics $T_a = 25$ °C $\pm 3$ °C

Parameter		Symbol	Conditions	Min	Тур	Max	Unit
Dark current		$I_D$	$V_R = 10 \text{ V}$		0.1	10	nA
Photocurrent *1	PNZ300	$I_L$	$V_R = 10 \text{ V}, L = 1000 \text{ lx}$	30	55		μΑ
	PNZ300F			5	7		
Peak emission wavelength		$\lambda_{\mathrm{p}}$	$V_R = 10 \text{ V}$		800		nm
Rise time *2		t <sub>r</sub>	$V_R = 20 \text{ V}, R_L = 50 \Omega$		1		ns
Fall time *2		$t_{\rm f}$			1		ns
Terminal capacitance		C <sub>t</sub>	$V_R = 10 \text{ V}, f = 1 \text{ MHz}$		7		pF
Half-power angle	PNZ300	θ	The angle from which photocurrent		10		0
	PNZ300F		becomes 50%		40		

- Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.
  - 2. Spectral sensitivity characteristics: Sensitivity for wave length over 400 nm maximum sensitivity ratio is 100%.
  - 3. This device is designed be disregarded radiation.
  - 4. \*1: Source: Tungsten (color temperature 2856 K)
    - \*2: Switching time measurement circuit



Note) The part numbers in the parenthesis show conventional part number.



Ambient temperature  $T_a$  (°C)

200

1000

1200

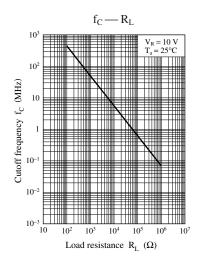
600

Wavelength λ (nm)

40

Half-power angle  $\,\theta\,$  (°)

80



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